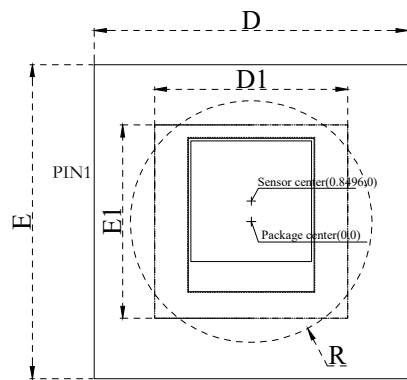
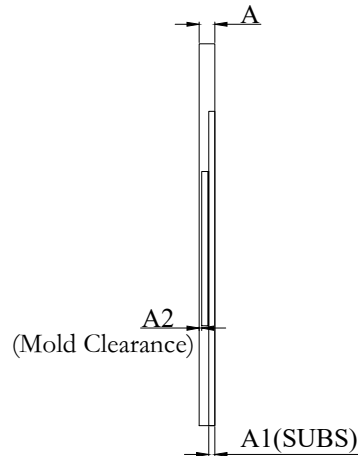


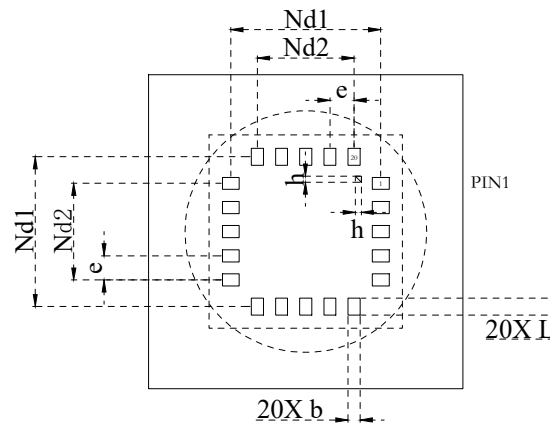
RoSH



Front View




Side View



Black View

机械尺寸/mm			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
D	12.900	13.000	13.100
E	12.900	13.000	13.100
A	0.620	0.650	0.680
A1	0.2300	0.2600	0.2900
A2	0.0950	0.1000	0.1050
Nd1	6.200 BSC		
Nd2	4.000 BSC		
R	Ø10.00 BSC		
e	1.000 BSC		
L	0.6000	0.7000	0.8000
b	0.4000	0.5000	0.6000
D1	7.9000	8.0000	8.1000
E1	7.9000	8.0000	8.1000
h	0.2000	0.2500	0.2550

Number	Pindefine	Number	Pindefine
1	SPI_CLK	11	VDD33IO_WDT
2	SPI_MOSI	12	VCCL
3	SPI_MISO	13	GPIO
4	SPI_CS	14	INT_GPIO
5	INTB	15	GND
6	RESET_N	16	WDO
7	VDDIO	17	WDI
8	VDD(VLDO18)	18	WDT_EN
9	GND	19	SW_VDDIO
10	VCC(VDD33)	20	GND

 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD		制图: Draw	Ninglin 2024.08.06	研发部: R&D Check	
图号 Drawing NO.	HY-POD-LGA0026		品质部: Quality Department	产品工程部: PE Check	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA20L (13X13X0.65-P1.0)		生技部: Technical Department	生产部: Product Department	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	审核: Checker
A4	1	mm	1:1	☉ □	核准: Approved